

Dariusz Klepacki

List of Publications by Year in descending order

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| # | ARTICLE | IF | CITATIONS |
|----|---|-----|-----------|
| 1 | Analysis of LED Lampsâ€™ Sensitivity to Surge Impulse. Electronics (Switzerland), 2022, 11, 1140. | 3.1 | 3 |
| 2 | Analysis of Electromagnetic Field Distribution Generated in an Semi-Anechoic Chamber in Aspect of RF Harvesters Testing. IEEE Access, 2021, 9, 92043-92052. | 4.2 | 5 |
| 3 | Analysis of propagation process of conductive electromagnetic disturbances in AC/DC low power converter. , 2017, , . | | 1 |
| 4 | Analysis of electromagnetic couplings in LTCC microcircuits. , 2016, , . | | 0 |
| 5 | Simulation of transient thermal states in layered electronic microstructures. Microelectronics Reliability, 2008, 48, 1021-1026. | 1.7 | 2 |
| 6 | Influence of geometrical parameters of mutual parallel paths on process of disturbances propagation. , 2008, , . | | 0 |
| 7 | Application of operational method in analysis of electromagnetic couplings in mutual coupled path systems of planar structures. , 2008, , . | | 0 |
| 8 | Reliability of Operation of Single Chip Microprocessor with Watchdog in Thermal Stress Conditions. , 2007, , . | | 0 |
| 9 | High Energy Pulse Generator in Reliability Researches of Thick-Film Structures. , 2007, , . | | 1 |
| 10 | Temperature Field Simulation of Thick-Film Microcircuits Using Electro-Thermal Analogy. , 2006, , . | | 1 |
| 11 | Three Dimensional RC Model of Heat Transfer in Thick-Film Multilayer Structure. , 2006, , . | | 2 |
| 12 | Modelling of Dynamic Temperature States in Layer Microelectronics Systems. , 2006, , . | | 2 |